BRIGHTEK

BRIGHTEK (EUROPE) LIMITED

Brighten Up The World With LED !

ISO/TS 16949:2009 BS EN ISO 14001:2004 QC 080000 IECQ HSPM

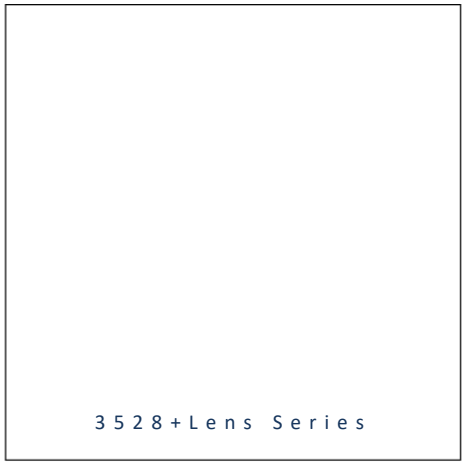
PRODUCT DATASHEET

- ▶ PLCC4 Top View SMD
- ▶ 3528+Lens Series
- ▶ Blue (470nm)

Release Date: 08 July 2021 Version: A1.1

N0B09S50 (13'' reel)

N0B09S50SR (7'' reel)



3528+Lens Series

RoHS Compliant

APPLICATIONS:

- LED Display
- Indicator
- Traffic Display
- Decoration Lighting

FEATURES:

- **Package:** PLCC4 Top View White SMT Package with Lens
- **Forward Current:** 20mA
- **Forward Voltage (typ.):** 3.2V
- **Luminous Intensity (typ.):** 1200mcd@20mA
- **Colour:** Blue
- **Dominant Wavelength (typ.):** 470nm
- **Viewing angle:** 30°
- **Materials:**
  - Die: InGaN
  - Resin: Epoxy (Water Clear)
  - L/F Finish: Ag Plated
- **Operating Temperature:** -40~+80°C
- **Storage Temperature:** -40~+85°C
- **Grouping parameters:**
  - Forward voltage
  - Luminous intensity
  - Dominant Wavelength
- **Soldering methods:** Reflow soldering
- **Preconditioning:** acc. to JEDEC Level 3
- **Packing:** 12mm tape with max.2000pcs/reel, ø330mm (13'') or max.600pcs/reel ø180mm (7'')

CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I_F	30	mA
Peak Forward Current Duty 1/8@1KHz	I_{FP}	125	mA
Reverse Voltage	V_R	5	V
Reverse Current @5V	I_R	10	μA
Power Dissipation	P_D	111	mW
Operating Temperature	T_{OPR}	-40~+80	°C
Storage Temperature	T_{STG}	-40~+85	°C

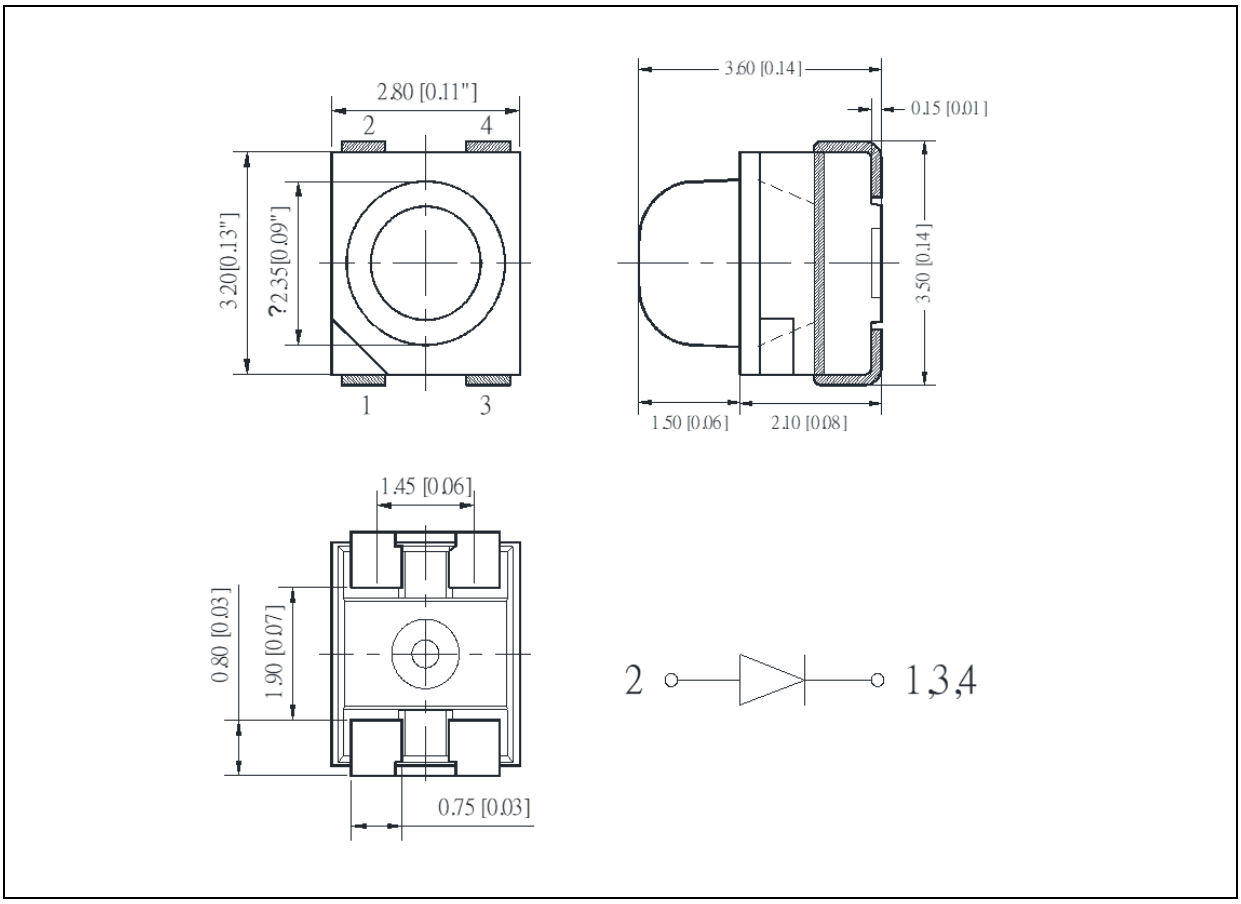
Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol	Values			Unit	Test Condition
		Min.	Typ.	Max.		
Forward Voltage	V_F	2.8	---	3.7	V	I_F=20mA
Luminous Intensity	I_V	1000	1200	2400	mcd	I_F=20mA
Dominant Wavelength	λ_D	465	---	475	nm	I_F=20mA
Peak Wavelength	λ_P	---	465	---	nm	I_F=20mA
Spectral Half Bandwidth	$\Delta\lambda$	---	25	---	nm	I_F=20mA
Viewing Angle	$2\theta_{1/2}$	---	30	---	deg	I_F=20mA

1. Luminous intensity (I_V) ±15%, Forward Voltage (V_F) ±0.1V, Viewing angle($2\theta_{1/2}$) ±5%

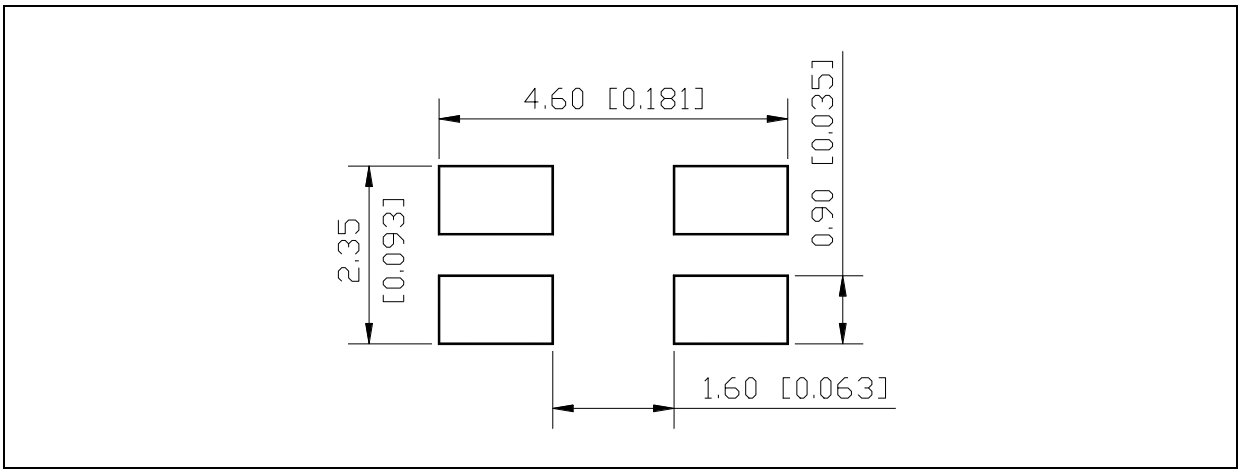
OUTLINE DIMENSION:

Package Dimension:



1. All dimensions are in millimetre (mm).
2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



1. Dimensions are in millimetre (mm).
2. Tolerance ±0.1mm with angle tolerance ±0.5°.

BINNING GROUPS:

Forward Voltage Classifications (I_F = 20mA):

Code	Min.	Max.	Unit
f	2.8	3.1	V
g	3.1	3.4	
h	3.4	3.7	

Luminous Intensity Classifications (I_F = 20mA):

Code	Min.	Max.	Unit
T	1000	1250	mcd
U	1250	1600	
V	1600	2000	
W	2000	2400	

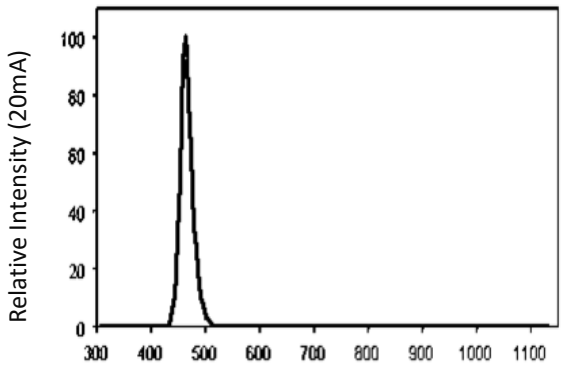
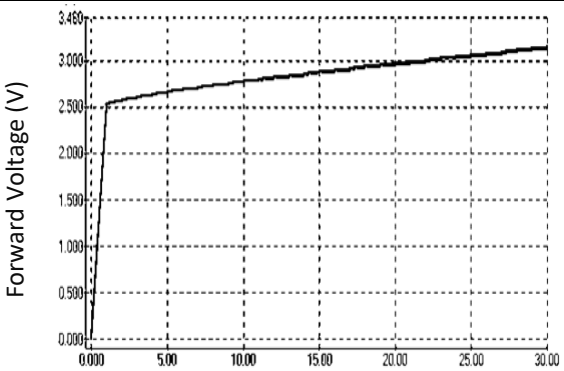
Dominant Wavelength Classifications (I_F = 20mA):

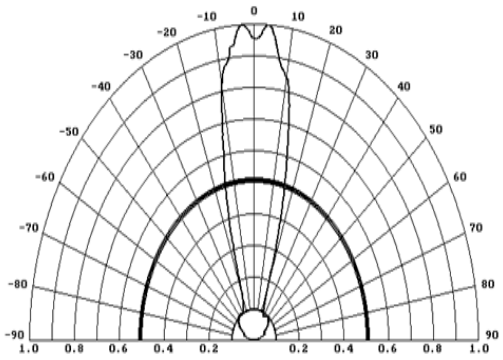
Code	Min.	Max.	Unit
G	465	467.5	nm
H	467.5	470	
I	470	472.5	
J	472.5	475	

Example Group Name on Label:

- **gTH 20** = **g** (3.1~3.4V) ► **T** (1000~1250mcd) ► **H** (467.5~470nm) ► **20** (IF=20mA)

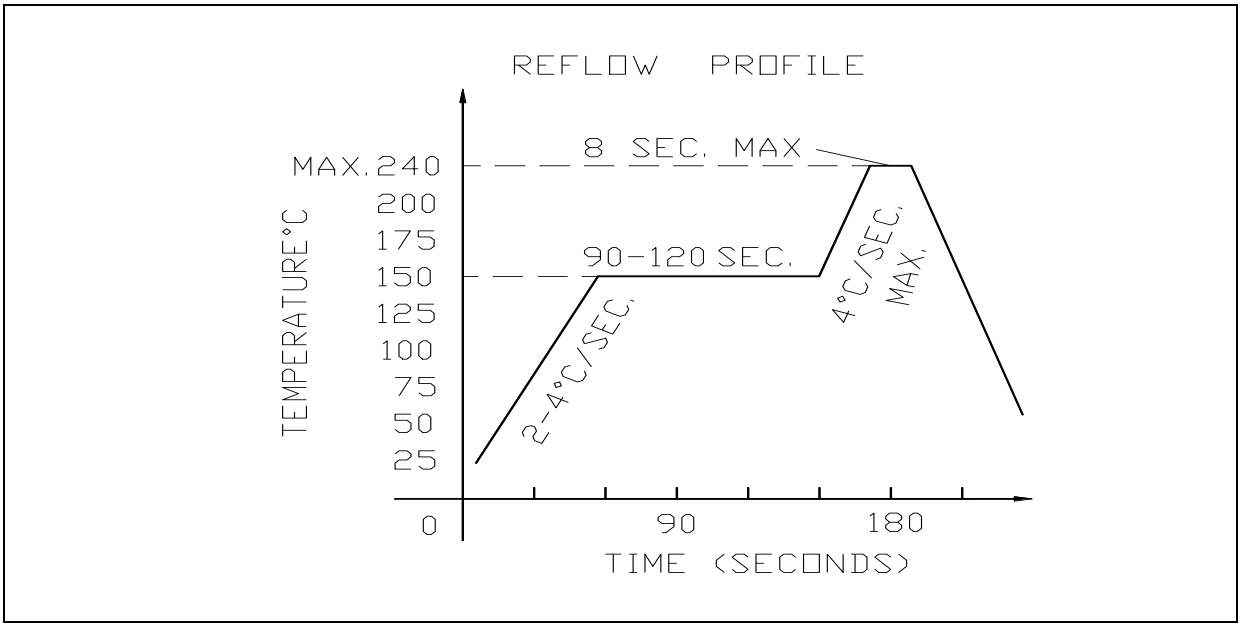
ELECTRO-OPTICAL CHARACTERISTICS:

Relative Spectral Distribution	Forward Current v.s. Forward Voltage
	

Directive Radiation


RECOMMENDED SOLDERING PROFILE:

Lead-free Solder:



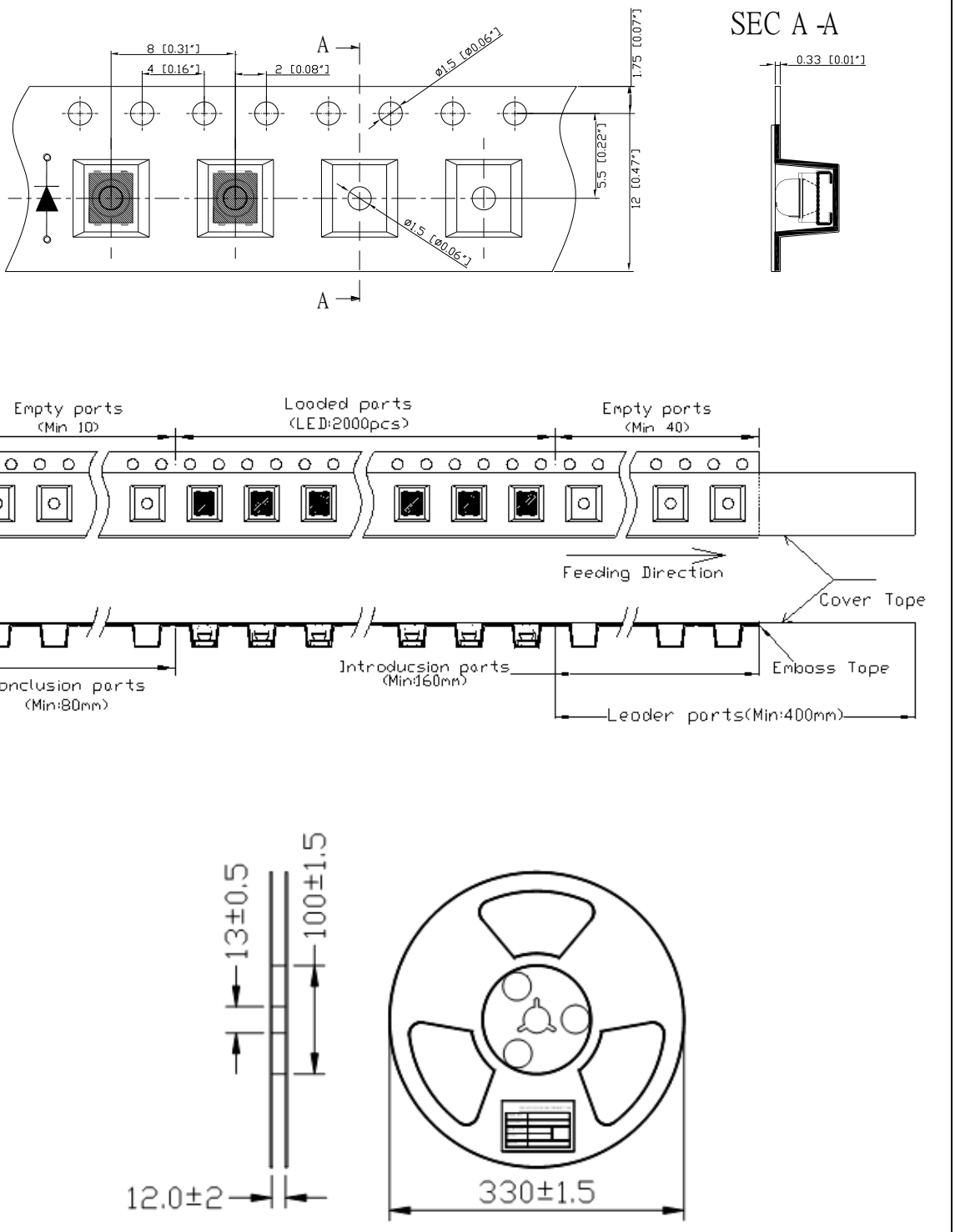
Note:

1. Maximum reflow soldering: 1 time.
2. Maximum soldering temperature is 240°C.
3. Before, during, and after soldering, should not apply stress on the components and PCB board.

PACKING SPECIFICATION:

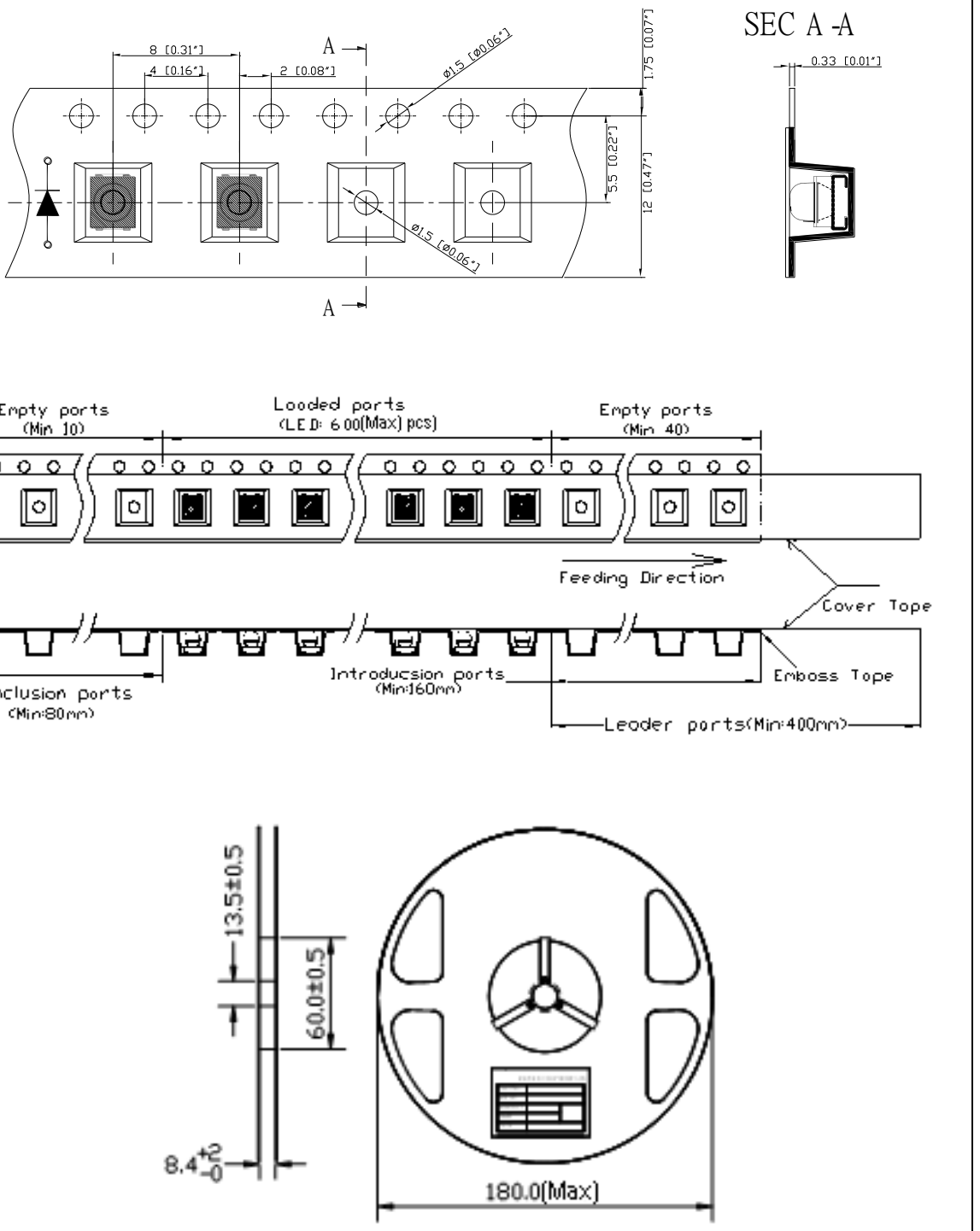
N0B09S50 - 13’’ Reel Dimension:

Max.2000pcs/reel



N0B09S50SR - 7'' Reel Dimension:

Max.600pcs/reel



PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

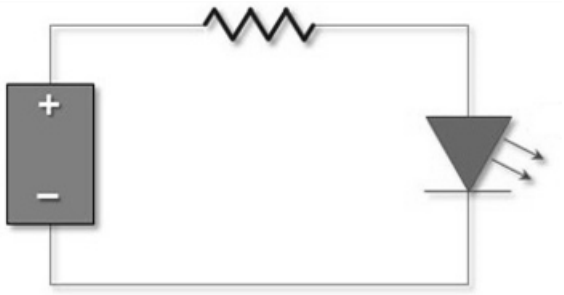
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.

REVISION RECORD:

Version	Date	Summary of Revision
A1.0	11/12/2018	Datasheet set-up.
A1.1	08/07/2021	New datasheet format.